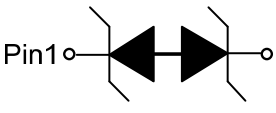
1- Line, Bi-directional, Transient Voltage Suppressor





SOD-323

Features

- Stand-off voltage: ±5V Max
- Transient protection for each line according to
  IEC61000-4-2(ESD): ±30kV (contact)
  IEC61000-4-5(surge): 24A (8/20μs)
- Low leakage current:
- Ultra low clamping voltage
- RoHS Compliant

Applications

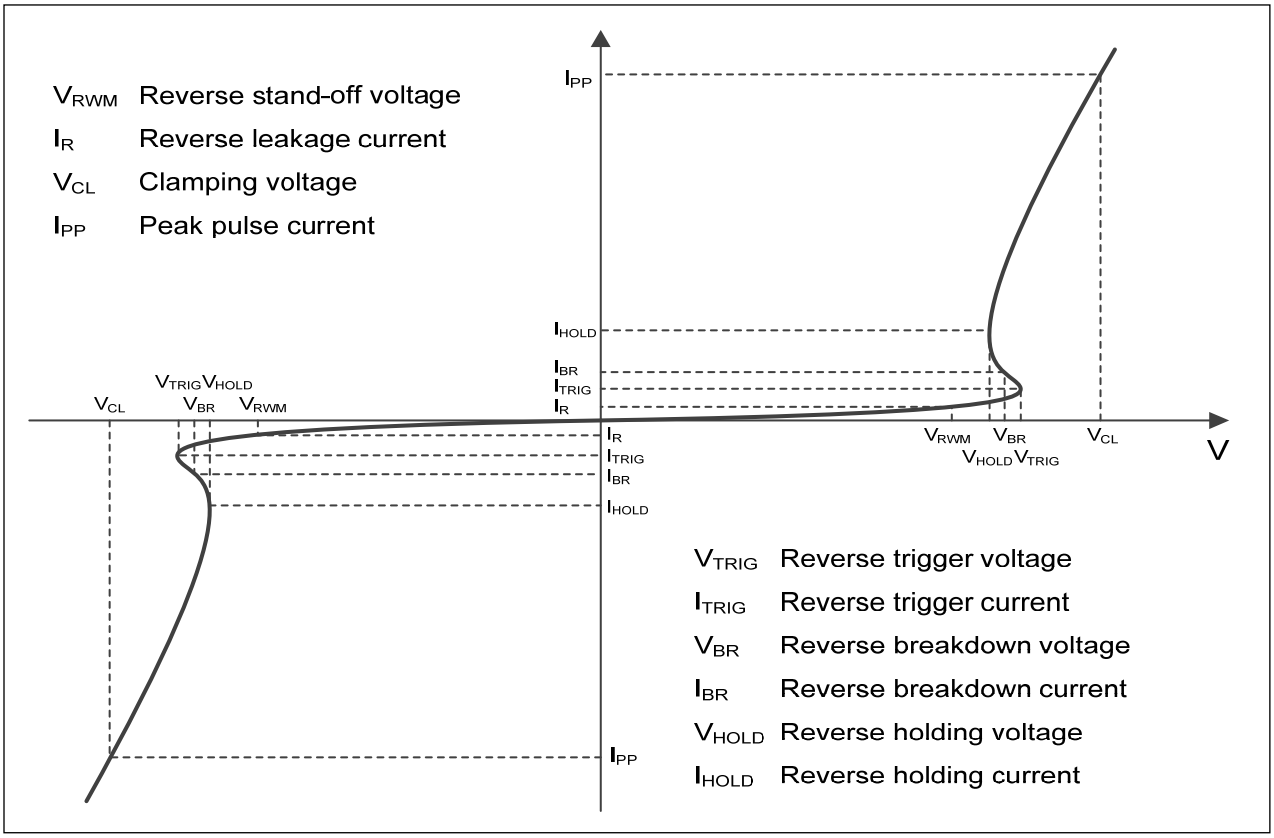
- Cellular Handsets and Accessories
- Personal Digital Assistants
- Notebooks and Handhelds
- Portable Instrumentation
- Peripherals
- Pagers Peripherals
- Desktop and Servers

Mechanical Data

- Package: SOD-323
- Lead Finish: Matte Tin
- Case Material: “Green” Molding Compound
- Moisture Sensitivity: Level 1 per J-STD-020
- Marking Information: See Below



■Definitions of electrical characteristics



■Maximum Ratings

PARAMETER	SYMBOL	LIMITS	UNIT
Peak pulse power (t_p = 8/20μs)	P_{pk}	300	W
Peak pulse current (t_p = 8/20μs)	I_{PP}	24	A
ESD according to IEC61000-4-2 air discharge	V_{ESD}	±30	KV
ESD according to IEC61000-4-2 contact discharge		±30	
Junction temperature	T_J	-55~150	℃
Storage temperature	T_{STG}	-55~150	℃

■Electrical Characteristics（T_a=25℃ Unless otherwise specified）

PARAMETER	Symbol	UNIT	Conditions	Min	Typ	Max
Reverse maximum working voltage	V_{RWM}	V				±5
Reverse leakage current	I_R	μA	V_{RWM} = 5V			0.5
Reverse breakdown voltage	V_{BR}	V	I_{BR} = 1mA	5.5		
Clamping voltage [1)]	V_{CL}	V	I_{PP} = 1A, t_p = 8/20μs		8.5	10
		V	I_{PP} = 10A, t_p = 8/20μs		9.5	11
		V	I_{PP} = 24A, t_p = 8/20μs		11	13
Junction capacitance	C_J	pF	V_R = 0V, f = 1MHz		66	80

Notes:
(1). Non-repetitive current pulse, according to IEC61000-4-5.

■Ordering Information (Example)

PREFERED P/N	PACKING CODE	UNIT WEIGHT(mg)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
ESD5V0D3BA	F2	Approximate 4	3000	30000	120000	7 reel

■ Characteristics (Typical)

Fig.1 8/20μs waveform per IEC61000-4-5

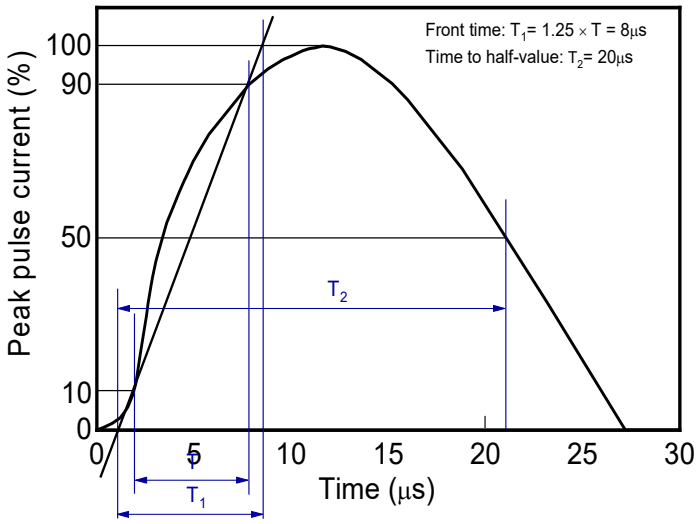


Fig.2 Contact discharge current waveform per IEC61000-4-2

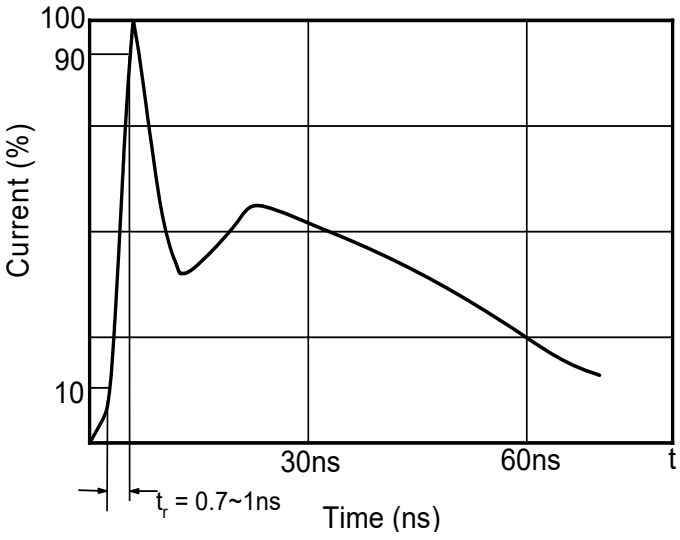


Fig.3 Clamping voltage vs. Peak pulse current

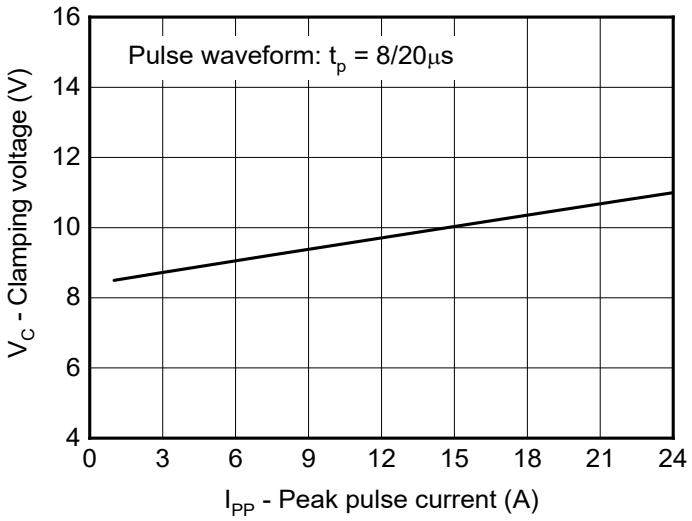


Fig.4 Capacitance vs. Reverse voltage

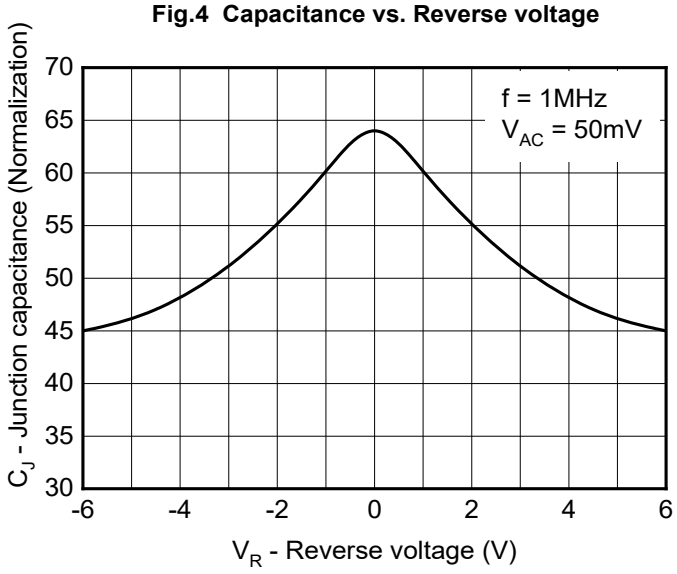


Fig.5 Non-repetitive peak pulse power vs. Pulse time

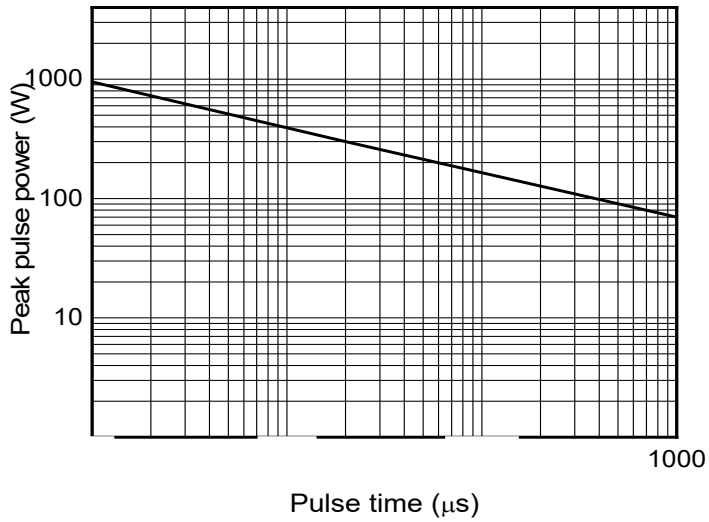
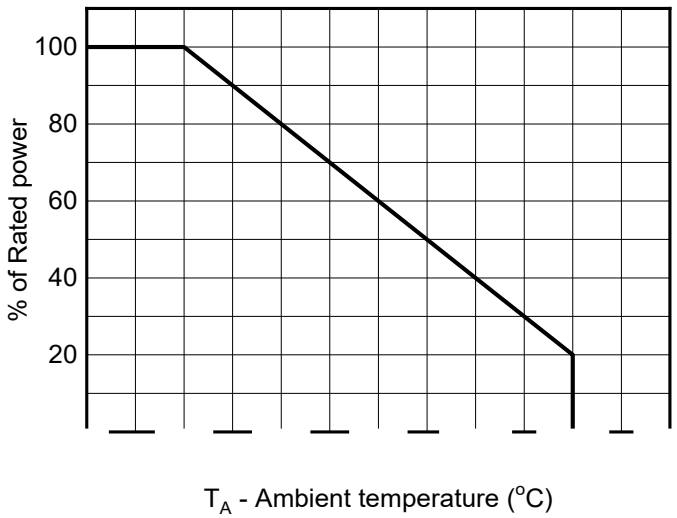
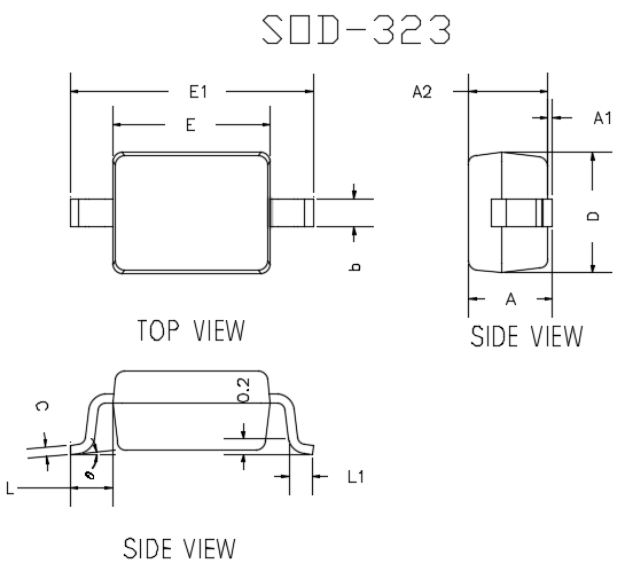


Fig.6 Power derating vs. Ambient temperature

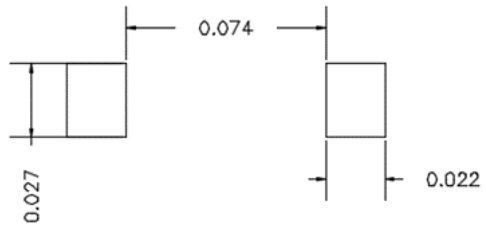


■ Outline Dimensions



DIMENSIONS				
DIM	INCHES		MM	
	MIN	MAX	MN	MAX
A	---	0.0393	---	1.0000
A1	0.0000	0.0039	0.0000	0.1000
A2	0.0314	0.0354	0.8000	0.9000
b	0.0098	0.0157	0.2500	0.4000
c	0.0031	0.0059	0.0800	0.1500
D	0.0472	0.0551	1.2000	1.4000
E	0.0629	0.0709	1.6000	1.8000
E1	0.0984	0.1063	2.5000	2.7000
L	0.0187TYP		0.475TYP	
L1	0.0098	0.0157	0.250	0.400
θ	0°	8°	0°	8°

■ Soldering Footprint



UNIT: inch

SUGGESTED SOLDER PAD LAYOUT

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